

2N5239-2N5240

SILICON NPN TRANSISTORS

FEATURES

- Available as "HR" (high reliability) screened per MIL-PRF-19500, JANTX level. Add "HR" suffix to base part number.
- Available as non-RoHS (Sn/Pb plating), standard, and as RoHS by adding "-PBF" suffix.

MAXIMUM RATINGS

Parameter	Symbol	2N5239	2N5240	Unit
Collector-base voltage	V_{CBO}	300	375	V
Collector-emitter voltage, $R_{BE} \le 50\Omega$	V _{CER(sus)}	250	350	V
Collector-emitter voltage	V _{CEO(sus)}	225	300	V
Emitter-base voltage	V _{EBO}	6		V
Collector current – continuous	Ic	5		А
Base current	I _B	2		Α
Total power dissipation				
T _C ≤ 25°C & V _{CE} ≤ 125V	P_{T}		00	W
T _C ≤ 25°C & V _{CE} ≤ 125V	r _T	FIGURE 1 FIGURE 1		
T _C > 25°C & V _{CE} > 125V				
Junction and storage temperature range	T _J , T _{stg}	-65 to 200		°C

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Parameter	Symbol	Conditions	2N5239		2N5240		Units
			Min	Max	Min	Max	
Collector cutoff current	I _{CEO}	V _{CE} = 200V, I _B = 0	-	5	-	2	mA
Collector cutoff current		V _{CE} = 300V, V _{BE} = -1.5V	-	4	-	-	
	I _{CEV}	V _{CE} = 375V, V _{BE} = -1.5V	-	-	-	2	mA
		V _{CE} = 300V, V _{BE} = -1.5V, T _C = 150°C	-	5	-	3	
Emitter cutoff current		$V_{EB} = 5V, I_{C} = 0$	-	5	-	1	^
	I _{EBO}	$V_{EB} = 6V, I_{C} = 0$	-	20	-	20	mA
Emitter-base breakdown voltage	V _{EBO}	I _B = 0.02A	6	-	6	-	V
Collector-emitter sustaining voltage	V _{CEO(sus)}	I _C = 0.2A	225	-	300	-	
	V _{CER(sus)}	$I_C = 0.2A$, $R_{BE} \le 50\Omega$	250	-	350	-	V
DC current gain		I _C = 0.4A, V _{CE} = 10V	20	80	20	80	
	h _{FE}	I _C = 2A, V _{CE} = 10V	20	80	20	80	
		$I_C = 4.5A$, $V_{CE} = 10V$	5	-	5	-	
Base-emitter voltage	V _{BE}	I _C = 2A, V _{CE} = 10V	-	3	-	3	V
Collector-emitter saturation voltage	.,	I _C = 2A, I _B = 0.25A	-	2.5	-	2.5	V
	V _{CE(sat)}	I _C = 4.5A, I _B = 1.125A	-	5	-	5	V
Current gain – bandwidth product	f⊤	I _C = 0.2A, V _{CE} = 10V	2	-	2	-	MHz
Output capacitance	Cobo	I _C = 0, V _{CB} = 10V, f _{test} = 1.0MHz	-	250	-	250	pF
Thermal resistance, junction to case	Rejc		-	1.75	-	1.75	°C/W

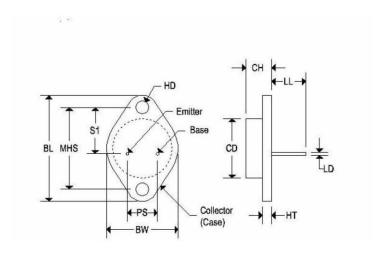


MECHANICAL CHARACTERISTICS

Case:	TO-3			
Marking:	Alpha-Numeric			
Polarity:	See below			

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	TO-3					
	Inches		Millimeters			
	Min	Max	Min	Max		
CD	-	0.875	-	22.220		
CH	0.250	0.380	6.860	9.650		
HT	0.060	0.135	1.520	3.430		
BW		1.050		26.670		
HD	0.131	0.188	3.330	4.780		
LD	0.038	0.043	0.970	1.090		
LL	0.312	0.500	7.920	12.700		
BL	1.550	REF	39.370 REF			
MHS	1.177	1.197	29.900	30.400		
PS	0.420	0.440	10.670	11.180		
S1	0.655	0.675	16.640	17.150		

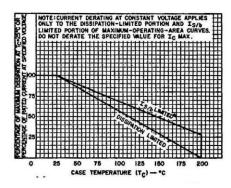


Fig. 1 - Derating curves for both types.

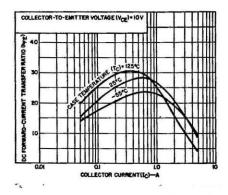


Fig. 2 — Typical dc beta characteristics for both types.



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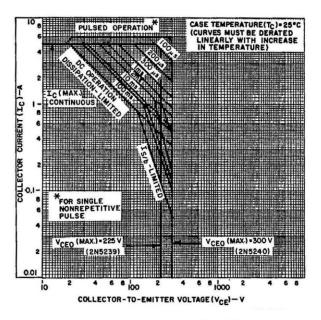


Fig. 3 - Maximum operating areas for both types.

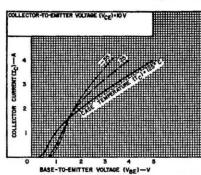


Fig. 4 — Typical transfer characteristics for both

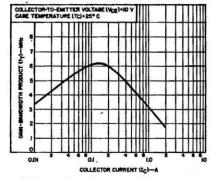


Fig. 6 — Typical gain-bandwidth product as a function of collector current for both types.

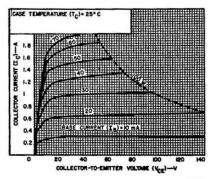


Fig. 5 — Typical output characteristics for both types.

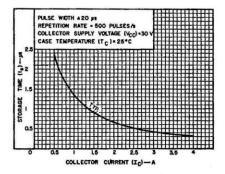


Fig. 7 — Typical saturated-switching time (storage) as a function of collector current for both types.



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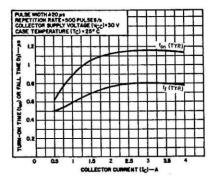


Fig. 8 — Typical saturated-time (turn-on or fall) as a function of collector current for both types.

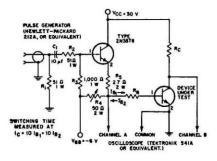


Fig. 9 — Circuit used to measure sustaining voltages, V_{CEO}(sus) and V_{CER}(sus) for both types.

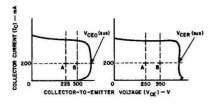


Fig. 10 — Oscilloscope display for V_{CEO}(sus) and V_{CER}(sus) measurement.

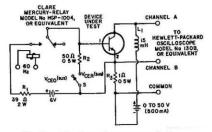


Fig. 11 — Circuit used to measure switching times for both types.

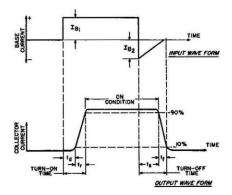


Fig. 12 — Phase relationship between input and output currents showing reference points for specification of switching times.